# 3A, 400V - 1000V Standard Bridge Rectifier

### FEATURES

TAIWAN

• Glass passivated chip junction

SEMICONDUCTOR

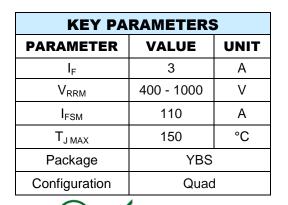
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

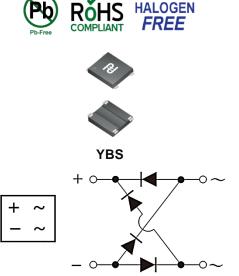
### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

### **MECHANICAL DATA**

- Case: YBS
- Molding compound meets UL 94V-0 flammability rating
- Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.220g (approximately)





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	YBS	YBS	YBS	YBS	UNIT	
			3004G	3005G	3006G	3007G		
Marking code on the devi	Marking code on the device			YBS3004G	YBS3005G	YBS3006G	YBS3007G	
Repetitive peak reverse voltage		V <sub>RRM</sub>	400	600	800	1000	V	
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	280	420	560	700	V	
Forward current		I <sub>F</sub>	3			Α		
Curren mank forward	t = 8.3ms	25°C		110			А	
Surge peak forward current, single half sine- wave superimposed on rated load		125°C	I <sub>FSM</sub>	88			А	
	t = 1.0ms	25°C		220			Α	
		125°C		175				А
Rating for fusing (t<8.3ms)			l <sup>2</sup> t	50.21			A <sup>2</sup> s	
Junction temperature			TJ	-55 to +150			°C	
Storage temperature			T <sub>STG</sub>	-55 to +150			°C	

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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	R <sub>ejl</sub>	22	°C/W	
Junction-to-ambient thermal resistance	R <sub>ØJA</sub>	61	°C/W	
Junction-to-case thermal resistance	R <sub>eJC</sub>	9	°C/W	

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	$I_F = 1.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.89	1.02	V
Forward voltage per diode <sup>(1)</sup>	$I_F = 3.0A, T_J = 25^{\circ}C$		0.93	1.10	V
Forward voltage per diode	$I_F = 1.5A, T_J = 125^{\circ}C$		0.76	0.90	V
	$I_F = 3.0A, T_J = 125^{\circ}C$		0.82	1.00	V
Deverse everent @ roted \/_per diade <sup>(2)</sup>	$T_J = 25^{\circ}C$		-	5	μA
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 125°C	I <sub>R</sub>	-	100	μA
Junction capacitance per diode	$1MHz, V_R = 4.0V$	CJ	33	-	pF

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

# ORDERING INFORMATION

ORDERING CODE	PACKAGE	PACKING
YBS3xG	YBS	3,000 / Tape & Reel

Notes:

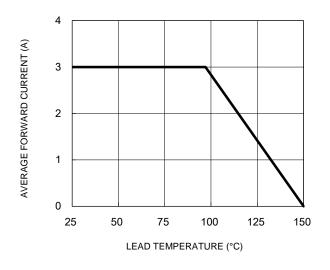
1. "x" defines voltage from 400V(YBS3004G) to 1000V(YBS3007G)



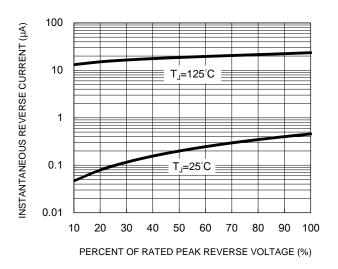
## **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve



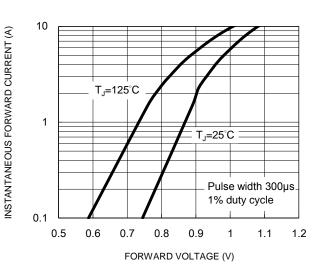
**Fig.3 Typical Reverse Characteristics** 



CAPACITANCE (pF)

#### Fig.2 Typical Junction Capacitance

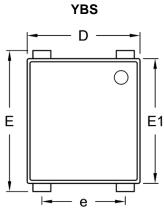


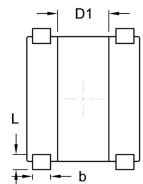


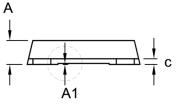


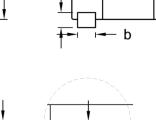
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## **PACKAGE OUTLINE DIMENSIONS**





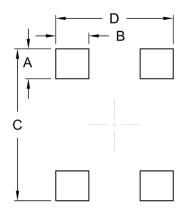




A1

DIM.	Unit	(mm)	Unit (inch)		
	Min.	Max.	Min.	Max.	
A	1.30	1.50	0.051	0.059	
A1	0.04	0.08	0.002	0.003	
b	0.95	1.15	0.037	0.045	
с	0.27	0.40	0.011	0.016	
D	6.50	6.70	0.256	0.264	
D1	2.90	3.10	0.114	0.122	
E	7.90	8.60	0.311	0.339	
E1	7.20	7.40	0.283	0.291	
е	5.00	5.20	0.197	0.205	
L	0.70	1.05	0.028	0.041	

## SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.80	0.070
В	2.00	0.078
С	9.15	0.360
D	7.10	0.279

### **MARKING DIAGRAM**



= Marking Code P/N

YW = Date Code

F = Factory Code



# YBS3004G - YBS3007G

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